# **Electronic Acknowledgement Receipt** FES ID: 1208910 Application Number: 10509200 Confirmation Number: 7343 Title of Invention: Method of retaining a solder mass on an article First Named Inventor: Jack Seidler Customer Number: 7278 Filer: Jay Philip Lessler/Lillian Garcia Filer Authorized By: Jay Philip Lessler Attorney Docket Number: 06026/100K359-US1 Receipt Date: 19-SEP-2006 Filing Date: 28-SEP-2005 Time Stamp: 16:56:51 Application Type: U.S. National Stage under 35 USC 371 International Application Number: Payment information:

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## File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Response to Election / Restriction Filed	00858451.pdf	18521	no	2

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